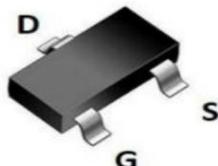




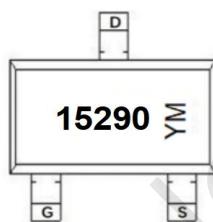
## Description

### N-channel Enhancement Mode Power MOSFET

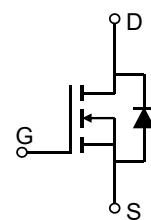
Features	Applications	RoHS
<ul style="list-style-type: none"><li>• 150V, 1.7A</li><li>• <math>R_{DS(ON)}</math> Typ= 240mΩ @ <math>V_{GS} = 10V</math></li><li>• Advanced Trench Technology</li><li>• Excellent <math>R_{DS(ON)}</math> and Low Gate Charge</li><li>• Lead Free</li></ul>	<ul style="list-style-type: none"><li>• Load Switch</li><li>• PWM Application</li><li>• Power Management</li></ul>	



SOT-23-3L



Marking and Pin Assignment



Schematic Diagram

### Package Marking and Ordering Information

Device Marking	Device	Outline	Package	Reel Size	Reel(pcs)	Per Carton (pcs)
15290	CRMJTL15290A	TAPING	SOT-23-3L	7"	3000	120000

### Absolute Maximum Ratings (@ $T_J = 25^\circ C$ unless otherwise specified)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-to-Source Voltage	150	V
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current $T_A = 25^\circ C$	1.7	A
		1.0	
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	6.8	A
$P_D$	Power Dissipation $T_A = 25^\circ C$	2.15	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(2)</sup>	58	$^\circ C/W$
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	$^\circ C$

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	150	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = 150\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.4	2.1	2.6	V
$R_{\text{DS(ON)}}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10\text{V}, I_D = 1\text{A}$	-	240.0	288.0	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	-	480	-	pF
$C_{\text{oss}}$	Output Capacitance		-	29	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	21	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 75\text{V}, I_D = 1.5\text{A}$	-	8.2	-	nC
$Q_{gs}$	Gate Source Charge		-	1.6	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge		-	2.2	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DD} = 75\text{V}$ $I_D = 1\text{A}, R_{\text{GEN}} = 6\Omega$	-	8	-	ns
$t_r$	Turn-On Rise Time		-	10	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	20	-	ns
$t_f$	Turn-Off Fall Time		-	15	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current	-	-	1.7	A	
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	6.8	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_s = 1.5\text{A}$	-	-	1.2	V

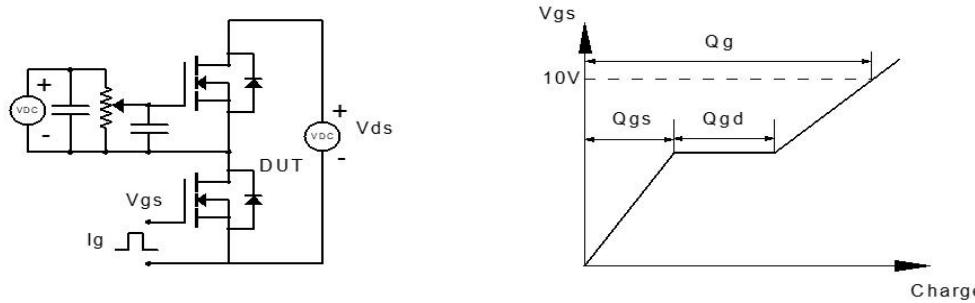
Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

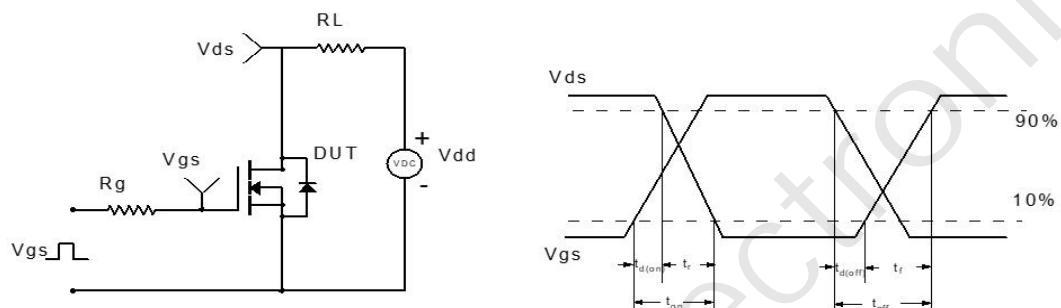
2.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB

3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

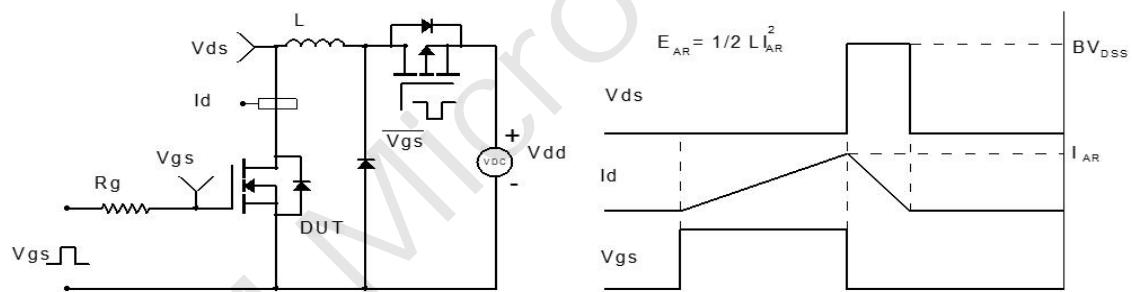
## Test Circuit



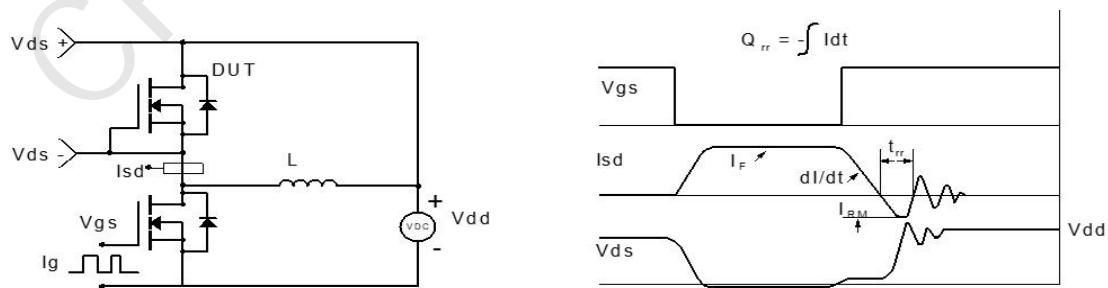
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

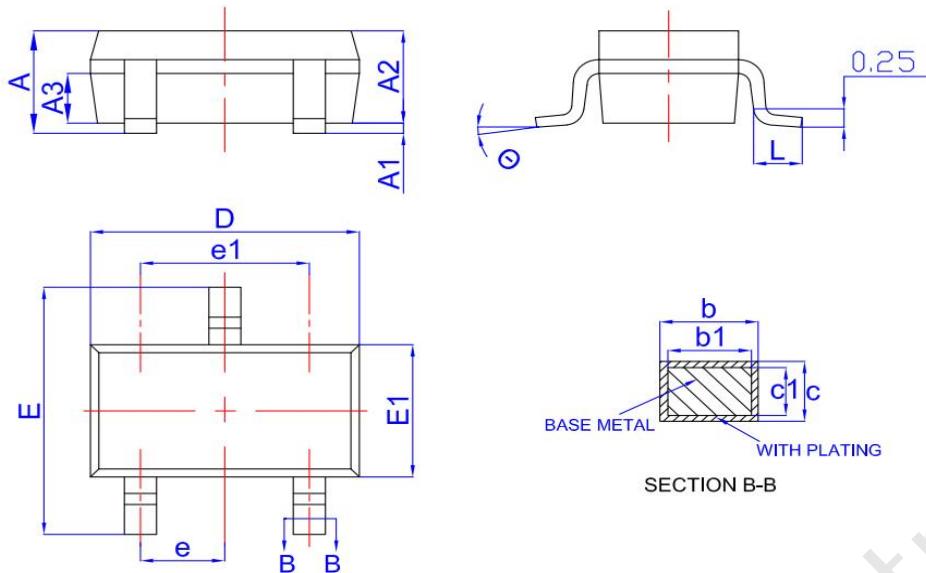


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(SOT-23-3L)



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	—	—	1.25
A1	0.04	—	0.10
A2	1.00	1.10	1.20
A3	0.55	0.65	0.75
b	0.3	—	0.4
b1	0.37	0.40	0.43
c	0.11	—	0.21
c1	0.10	0.13	0.16
D	2.72	2.92	3.12
E	2.60	2.80	3.00
E1	1.40	1.60	1.80
e	0.95BSC		
e1	1.90BSC		
L	0.30	—	0.60
Θ	0	—	8°

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